APPLICA	BLE STAN	IDARD									
	OPERATING		-35°C TO + 85°C(N	NOTE 1)	STOR		RE RANG	E	-10°C TO + 60°C(NOTE:	3)
RATING	TEMPERATURE RANGE OPERATING HUMIDITY RANGE		20 % TO 80 % (NO		STORAGE HUMIDITY R				40 % TO 70 % (N		.,
		INGE	<u> </u>	·	APPLI	CABLE		+	· · ·		
	VOLTAGE		AC/DC 100V AWG 28 : 1.0		CONNECTOR APPLICABL				DF50-*DS-1C DF50-2830SCF		
CURRENT			AWG 30 : 0.9		CONTACT		_		DF50-3032SCF		
			AWG 32 : 0.7 A				01 00 000200				
	•		SPEC	CIFICA	OITA	NS		•			
TI	EM		TEST METHOD				F	REQU	IIREMENTS	QT	АТ
	RUCTION										
GENERAL EX	(AMINATION	VISUALLY AND BY MEASURING INSTRUMENT.			——/ [*]	ACCORDING TO DRAWING.				X	X
MARKING		CONFIRMED VISUALLY. ACTERISTICS								X	X
			5 1105 ' MAX	Hz).	30	0mΩ N	IAX.				1
INSULATION			,							X	-
RESISTANC		100V DC.				00ΜΩ	MIIN.			X	-
VOLTAGE P	ROOF	300V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				Х	_
	NICAL CHA				-						
MECHANICAL OPERATION		30TIMES INSERTIONS AND EXTRACTIONS.				① CONTACT RESISTANCE: 50mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				x	_
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 10 CYCLE FOR EACH, FOR 3 DIRECTIONS.			1.	1 NO ELECTRICAL DISCONTINUITY OF 1μs. 2 NO DAMAGE, CRACK OR LOOSENESS OF PARTS.					
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				<u> </u>					
			ACTERISTICS							Т	
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 TO 95 %, 96 h.				 ① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 100MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				X	_
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→+85°C TIME 30→ 30min. UNDER 5 CYCLES. THE TRANSFERRING TIME OF THE TANK IS 2~3 min.				① CONTACT RESISTANCE: 50mΩ MAX. ② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				Х	_
COUN	T D	DESCRIPTION OF REVISIONS D		DESIGN	ESIGNED			CHECKED		ATE	
<u> </u>							APPRO	VED	TO CAVATA	00.7	20. 0
							CHECK		TS. SAKATA MN. KENJO	<u> </u>	09. 07
						DESI					09. 07 09. 07
							DESIG		TT, OHSAKO		09. 07 09. 07
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			חח	7.1.07.07.0			ELC4-326227		.J. U		
								DF50-*DP-1V(51)			
117					CODE NO.		0.00=		0	1/2	
FORM HD0011-2-1		COI			CODE	EINO. ULUUU-			0L000	U	1/2

SPECIFICATIONS								
ITEM	TEST METHOD	REQUIREMENTS	QT	AT				
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, 245°C FOR INSERTION DURATION, 5 sec.	SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	X	_				
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING «REFLOW AREA» MAX250°C WITHIN 10 sec MIN 220°C WITHIN 60 sec «PREHEATING AREA» 150~180°C 90~120s 2) MANUAL SOLDERING SOLDERING IPON TEMPERRATURE 350±10°C SOLDERING TIME 3~4s. NO STRENGTH ON CONTACT.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	X	_				
DEMADKS								

REMARKS

NOTE 1: INCLUDING THE TEMPERATURE RISE BY CURRENT.

NOTE 2: NON-CONDENSING

NOTE 3: APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD.

AFTER PCB BOARD, OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION

Unless otherwise specifid, refer to JIS C 5402.

Note QT:Q	ualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC4-326227-00		
HRS	SPECIFICATION SHEET	PART NO.	DF50-*DP-1V(51)			
11.0	HIROSE ELECTRIC CO., LTD.	CODE NO		CL665-	A	2/2